(P)

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		APPLICABLE	DIVISION	_
		DEVELOPME DISPLAY DE	NT DEPARTMENT 2 VICE UNIT 1	
	SPECIFICATION			

DEVICE SPECIFICATION for CGS Color LCD Module $(1440 \times RGB \times 2560 \text{ dots})$

Model No.

LS060R1SX02

BY	
DATE	_
CUSTOMER'S APPROVALDAT	E

Hidefire Boucestle PRESENTED / HIDEHIKO YAMASHITA

MANAGER DEVELOPMENT DEPARTMENT 2 DISPLAY DEVICE UNIT 1 DISPLAY DEVICE BUSINESS DIVISION SHARP CORPORATION

	DECORDS OF D	EVICION		DOC. First issue	9.July.2014
	RECORDS OF R	LVISION		Model No.	LS060R1SX02
			Spec. No.	LCY-1314605C	
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09.July.2014				First Issue	
24.July.2014	P31	B	Removed tv	vo insulation tapes from the	FPC.
09.September .2014	P.18 & P.19	C		Power on sequence mo (tsAVP : 1ms=>20	dification 0ms)
9 2					



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- O The device listed in these specification sheets was designed and manufactured for use in Telecommunication equipment (terminals)
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- O Do not use the device for equipment that requires an extreme level of reliability, such as aerospace applications, telecommunication equipment (trunk lines), nuclear power control equipment and medical or other equipment for life support.
- O SHARP assumes no responsibility for any damage resulting from the use of the device which does not comply instructions and the precautions specified in these specification sheets.
- O Contact and consult with a SHARP sales representative for any questions about this device.

[For handling and system design]

- (1) Do not scratch the surface of the polarizer film as it is easily damaged.
- (2) If the cleaning of the surface of the LCD panel is necessary, wipe it swiftly with cotton or other soft cloth. Do not use organic solvent as it damages polarizer.
- (3) Water droplets on polarizer must be wiped off immediately as they may cause color changes, or other defects if remained for a long time.
- (4) Since this LCD panel is made of glass, dropping the module or banging it against hard objects may cause cracks or fragmentation.
- (5) Certain materials such as epoxy resin (amine's hardener) or silicone adhesive agent (de-alcohol or de-oxym) emits gas to which polarizer reacts (color change). Check carefully that gas from materials used in system housing or packaging do not hart polarizer.
- (6) Liquid crystal material will freeze below specified storage temperature range and it will not get back to normal quality even after temperature comes back within specified temperature range. Liquid crystal material will become isotropic above specified temperature range and may not get back to normal quality. Keep the LCD module always within specified temperature range.
- (7) Do not expose LCD module to the direct sunlight or to strong ultraviolet light for long time.
- (8) If the LCD driver IC (COG) is exposed to light, normal operation may be impeded. It is necessary to design so that the light is shut off when the LCD module is mounted.



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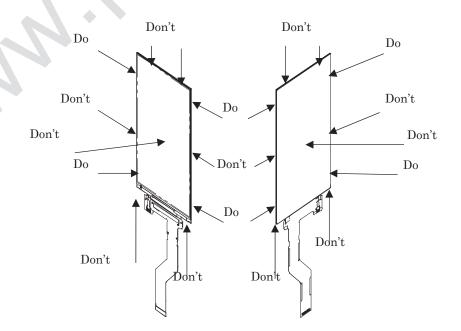
- (9) Do not disassemble the LCD module as it may cause permanent damage.
- (10) As this LCD module contains components sensitive to electrostatic discharge, be sure to follow the instructions in below.
- 1 Operators

Operators must wear anti-static wears to prevent electrostatic charge up to and discharge from human body.

- 2 Equipment and containers
 - Process equipment such as conveyer, soldering iron, working bench and containers may possibly generate electrostatic charge up and discharge. Equipment must be grounded through 100Mohms resistance. Use ion blower.
- 3 Floor

Floor is an important part to leak static electricity which is generated from human body or equipment. There is a possibility that the static electricity is charged to them without leakage in case of insulating floor, so the counter measure (electrostatic earth: $1 \times 10^8 \Omega$) should be made.

- 4 Humidity
 - Proper humidity of working room may reduce the risk of electrostatic charge up and discharge. Humidity should be kept over 50% all the time.
- ⑤Transportation/storage
 - Storage materials must be anti-static to prevent causing electrostatic discharge.
- **6**Others
 - Protective film is attached on the surface of LCD panel to prevent scratches or other damages. When removing this protective film, remove it slowly under proper anti-ESD control such as ion blower.
- (11) Hold LCD very carefully when placing LCD module into the system housing. Do not apply excessive stress or pressure to LCD module. Do not to use chloroprene rubber as it may affect on the reliability of the electrical interconnection.
- (12) Do not hold or touch LCD panel to flex interconnection area as it may be damaged.
- (13) As the binding material between LCD panel and flex connector mentioned in 12) contains an organic material, any type of organic solvents are not allowed to be used. Direct contact by fingers is also prohibited.
- (14) When carrying the LCD module, place it on the tray to protect from mechanical damage. It is recommended to use the conductive trays to protect the CMOS components from electrostatic discharge. When holding the module, hold the Plastic Frame of LCD module so that the panel, COG and other electric parts are not damaged.





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- (15) Do not touch the COG's patterning area. Otherwise the circuit may be damaged.
- (16) Do not touch LSI chips as it may cause a trouble in the inner lead connection.
- (17) Place a protective cover on the LCD module to protect the glass panel from mechanical damages.
- (18) LCD panel is susceptible to mechanical stress and even the slightest stress will cause a color change in background. So make sure the LCD panel is placed on flat plane without any continuous twisting, bending or pushing stress.
- (19) Protective film is placed onto the surface of LCD panel when it is shipped from factory. Make sure to peel it off before assembling the LCD module into the system. Be very careful not to damage LCD module by electrostatic discharge when peeling off this protective film. Ion blower and ground strap are recommended.
- (20) Make sure the mechanical design of the system in which the LCD module will be assembled matches specified viewing angle of this LCD module.
- (21) This LCD module does not contain nor use any ODS (1,1,1-Trichloroethane, CCL4) in all materials used, in all production processes.

[For operating LCD module]

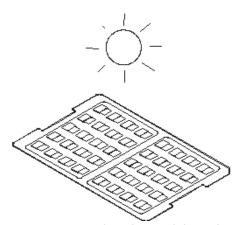
- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) At the shipment, adjust the contrast of each LCD module with electric volume. LCD contrast may vary from panel to panel depending on variation of LCD power voltage from system.
- (3) As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

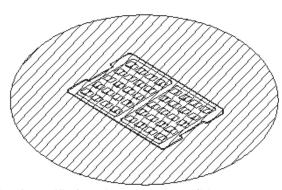
[Precautions for Storage]

- (1) Do not expose the LCD module to direct sunlight or strong ultraviolet light for long periods. Store in a dark place.
- (2) The liquid crystal material will solidify if stored below the rated storage temperature and will become an isotropic liquid if stored above the rated storage temperature, and may not retain its original properties. Only store the module at normal temperature and humidity (25±5°C,60±10%RH) in order to avoid exposing the front polarizer to chronic humidity.
- (3) Keeping Method
 - a. Don't keeping under the direct sunlight.
 - b. Keeping in the tray under the dark place.

DON'T

DO





- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) Be sure to prevent light striking the chip surface.





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[Other Notice]

- (1) Do not operate or store the LCD module under outside of specified environmental conditions.
- (2) As electrical impedance of power supply lines (VDDIO-GND) are low when LCD module is working, place the de-coupling capacitor nearby LCD module as close as possible.
- (3) Reset signal must be sent after power on to initialize LSI. LSI does not function properly until initialize it by reset signal.
- (4) Generally, at power on, in order not to apply DC charge directly to LCD panel, supply logic voltage first and initialize LSI logic function including polarity alternation. Then supply voltage for LCD bias. At power off, in order not to apply DC charge directly to LCD panel, execute Power OFF sequence and Discharge command.
- (5) Don't touch to FPC surface, exposed IC chip, electric parts and other parts, to any electric, metallic materials.
- (6) No bromide specific fire-retardant material is used in this module.
- (7) Do not display still picture on the display over 2 hours as this will damage the liquid crystal.
- (8) The connector used in this LCD module is the one Sharp have not ever used. Therefore, please note that the quality of this connector concerned is out of Sharp's quarantee.
- (9) If the LCD module is kept under a high-humidity environment or it is used, the LCD module will curve. Be fully careful about the keeping constraints and production-process environment of the LCD module.
- (10) When you connect the LCD module to your set, or when you remove, please turn OFF the power supply of your set.
- (11) When you bend FPC, please perform the straight radius more than uniform phi=0.6[mm].

[Precautions for Discarding Liquid Crystal Modules]

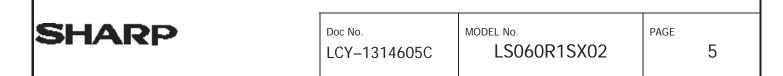
COG: After removing the LSI from the liquid crystal panel, dispose of it in a similar way to circuit boards from

LCD panel: Dispose of as glass waste. This LCD module contains no harmful substances. The liquid crystal panel contains no dangerous or harmful substances. The liquid crystal panel only contains an extremely small amount of liquid crystal (approx.100mg) and therefore it will not leak even if the panel should break.

-Its median lethal dose (LD50) is greater than 2,000 mg/kg and a mutagenetic (Aims test: negative) material is employed.

FPC: Dispose of as similar way to circuit board from electric device.





1. Application

This data sheet is to introduce the specification of LS060R1SX02 active matrix 16,777,216 color LCD module. Main color LCD module is controlled by Driver IC (R63419 with 1/3 RAM).

If any problem occurs concerning the items not stated in this specification, it must be solved sincerely by both parties after deliberation.

As to basic specification of driver IC refer to the IC specification and handbook.

2. Construction and Outline

Construction: LCD panel, Driver (COG), FPC with electric components, 16 White LED lumps, prism sheet, diffuser, light guide and reflector and plastic frame to fix them mechanically.

Outline: See page 31page

Connection: B to B connector (Japan Aviation Electronics Industry, Ltd, WP7B-P050VA1 50 pins, 0.4mm pitch) There shall be no scratches, stains, chips, distortions and other external drawbacks that may affect the display function.

Rejection criteria shall be noted in Inspection Standard (IIS-121023)

In order to realize thin module structure, double-sided adhesive tapes are used to fix LCD panels. As these tapes do not guarantee to permanently fix the panels, LCD panel may rise from the module when shipped from factory.

So please make sure to design the system to hold the edges of LCD panel by the soft material such as sponge when LCD module is assembled into the cabinet.

3. Mechanical Specification

Table 1

<u>rable r</u>			
Item	Specifications	Unit	Remarks
Active area	74.52(H) X 132.48(V)	mm	
Pixel format	1440(H)×2560(V)	Pixel	
Pixer format	1 Pixel =R+G+B dots	-	
Pixel pitch	0.01725(H) x 0.05175(V)	mm	
Pixel configuration	R,G,B vertical stripes	-	
Display mode	Normally Black	-	
LDC Driving method	DC Driving / Column Inversion	-	
Liquid Crystal Mode	New Mode2	-	
Number of colors	16,777,216	Colors	24 bits
Outline dimensions	76.92(W)×140.13 (H)×1.25(D) TYP	mm	Note 3-1
Mass	Approx 21.5	g	

Note 3-1) The above-mentioned table indicates module sizes without some projections and FPC. For detailed measurements and tolerances, please refer to page 31.



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4. Absolute Maximum Ratings

(4-1) Electrical absolute maximum ratings

<u>Ta</u>	ble 2		

		Table 2			Ta=25 °C
Parameter	Symbol	Min	Max	Unit	Remark
Supply Voltage	IOVCC-GND	-0.3	+4.6	V	*1
	VSP-GND	-0.3	+6.5	٧	*1
	VSN-GND	-6.5	+0.3	V	*1

^{*1:} Voltage applied to GND pins. GND pin conditions are based on all the same voltage (0V). Always connect all GND externally and use at the same voltage.

Environment Conditions

Table 3

Item	Тор		Tstg		Remark	
	MIN.	MAX.	MIN.	MAX.		
Ambient temperature	-20 °C	+60°C	-30 °C	+70°C	Note 2)	
Humidity	Note	e 1)	Note	e 1)	No condensation	

Note1) Ta ≤ 40 °C......95 % RH Max

Note2) Ta > 40 °C......Absolute humidity shall be less than Ta=40 °C /95 % RH.

As opt-electrical characteristics of LCD will be changed, dependent on the temperature, the confirmation of display quality and characteristics has to be done after temperature is set at 25 °C and it becomes stable.

Be sure not to exceed the rated voltage, otherwise a malfunction may occur.



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5. Electrical Specifications

(5-1) Electrical characteristics

(5-1) Electrical characteristics	•	Table 4			7	a=25	°C, GND=0V
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	Applicable Pin
Supply voltage1	IOVCC-GND	Ta=-20 ~ 60 °C	1.7	1.8	1.9	V	(note 1)
Supply voltage2	VSP-GND	Ta=-20 ~ 60 °C	5.60	5.75	5.90	V	(note 1)
Supply voltage3	VSN-GND	Ta=-20 ~ 60 °C	-5.90	-5.75	-5.60	V	(note 1)
"H" level input voltage	V _{IH}	T- 20 (0.00	0.7 IOVCC	-	IOVCC	V	(, , , , ,
"L" level input voltage	V_{IL}	Ta=-20 ~ 60 °C	0	-	0.310VCC	V	(note 2)
"H" level Input current	I _{IH}	Ta=-20 ~ 60 °C	-	-	10	μΑ	
"L" level Input current	I _{IL}	1d=-20~00 C	-10	-	-	μΑ	
"H" level Output voltage	V _{OH}	Ta=-20 ~ 60 °C	0.8 IOVCC		IOVCC	V	I _{OH} =-0.1mA
"L" level Output voltage	V_{OL}			_	0.2 IOVCC	V	$I_{OL} = +0.1 \text{mA}$
		MIPI high speed mode					
Common mode voltage High Speed receive mode	VCMRX(DC)	Ta=-20 ~ 60 °C	70		330	mV	(note 3)
Differential input high threshold voltage	VIDTH	Ta=-20 ~ 60 °C	-	-	70	mV	(Note 3)
Differential input low threshold voltage	VIDTL	Ta=-20~60 °C	-70	-	-	mV	(Note 3)
Single-ended input high voltage	VIHHS	Ta=-20 ~ 60 °C	-	-	460	mV	(Note 3)
Single-ended input low voltage	VILHS	Ta=-20~60 °C	-40	-	-	mV	(Note 3)
		MIPI LP mode					
Logic High level input voltage	VIH	Ta=-20~60 °C	880		1350	mV	(Note 3)
Logic Low level input voltage	VIL	Ta=-20 ~ 60 °C	-50		550	mV	(Note 3)
Logic High level output voltage	VOH	Ta=-20 ~ 60 °C	1.1	1.2	1.3	V	(Note 3)
Logic Low level output voltage	VOL	Ta=-20~60 °C	-50		50	mV	(Note 3)
Logic 0 contention threshold	VILCD	Ta=-20 ~ 60 °C	-	-	200	mV	(Note 3)
Logic 1 contention threshold	VIHCD	Ta=-20 ~ 60 °C	450	-	-	mV	(Note 3)
	liovcc1	Ta=25 °C	-	15	21	mA	(note 4)
Current consumption	Ivsp1	Ta=25 °C	-	16.2	22.7	mA	(note 4)
	Ivsn1	Ta=25 °C	-	14	19.6	mA	(note 4)

- (Note 1) Include Ripple Noise
- (Note 2) Applied overshoot
- VCMRX(DC) = (VP + VDN)/2;(Note 3)

Minimum 110mV/-110mV HS differential swing is required for display data transfer. Measurement conditions: Ta=25°CFull screen white pattern, VSP=5.75V/VSN=-5.75V/IOVCC=1.8V, (Note 4) Still image(Command mode)

Global LCD Panel Exchange Center

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(5-2) LED back light

(1) At main panel the back light uses 16pcs edge light type white LED.

Table 5

Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit	Remark
Forward current	Ta=25 °C	I _{LED}	-	20*1	-	mA	LEDA
							LEDC1-/LEDC2-

LED lamp: NSSW304D (NICHIA)

^{*}Please consider Allowable Forward Current on used temperature (refer to Ambient Temperature vs. Allowable Forward Current curve)

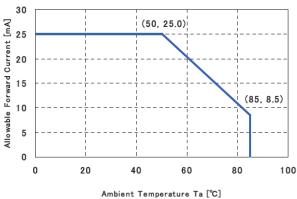


Fig.1 LED Characteristic(De-rating Curve)

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	I _F	25	mA
Pulse Forward Current	I_{FP}	80	mA
Reverse Voltage	V _R	5	V
Power Dissipation	P _D	82.5	mW
Operating Temperature	Topr	-30~85	°C
Storage Temperature	T _{stg}	-40~100	°C
Junction Temperature	Tı	105	°C

^{*} Absolute Maximum Ratings at T_A=25°C.

(2) Initial Electrical/Optical Characteristics

Item		Symbol	Condition	Тур	Max	Unit
Forward Voltage		V _F	I _F =20mA	3.0	19	V
Reverse Current		IR	V _R =5V	928	023	μА
Luminous Flux (Chromaticity Coordinate1)		$\Phi_{\rm v}$	I _F =20mA	8.0	10	lm
Luminous Intensity (Chromaticity Coordinate1)		I _v	I _F =20mA	2.55	1.6	cd
Characticity Consultanted	X	-	I _F =20mA	0.300	1.01	9,81
Chromaticity Coordinate1	У	. 10	I _F =20mA	0.295	9 <u>2</u> 4	9 PE
Luminous Flux (Chromaticity Coordinate2)		Ф	I _F =20mA	7.65	(S <u>F</u>)	lm
Luminous Intensity (Chromaticity Coordinate2)		I _v	I _F =20mA	2.4	141	cd
Characticity Consultants 2	x	100	I _F =20mA	0.290	12	629
Chromaticity Coordinate2		15	I _F =20mA	0.275	7 5 4	853
Thermal Resistance		Reas	-	120	180	°C/W

^{*} Characteristics at TA=25°C.

^{*1} per one piece of LED

^{*} I_{FP} conditions with pulse width ≤ 10 ms and duty cycle ≤ 10 %.

^{*} Luminous Flux value as per CIE 127:2007 standard.

^{*} Chromaticity Coordinates as per CIE 1931 Chromaticity Chart.

^{*} R_{83S} is Thermal Resistance from junction to T_S measuring point.



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Pin No	Symbol	Description	I/O	Remarks
1	GND	Ground	-	Romano
2	DSI_A_D3N	MIPI data3 negative signal of MIPI Port A	I	
3	DSI_A_D3P	MIPI data3 positive signal of MIPI Port A	I	
4	GND	Ground	_	
5	DSI_A_CLKN	MIPI clock negative signal of MIPI Port A	I	
6	DSI_A_CLKP	MIPI clock positive signal of MIPI Port A	I	
7	GND	Ground	_	
8	DSI_A_D2N	MIPI data2 negative signal of MIPI Port A	I	
9	DSI_A_D2P	MIPI data2 positive signal of MIPI Port A		
10	GND	Ground		
11	DSI_B_D1P	MIPI data1 positive signal of MIPI Port B		
12	DSI B D1N	MIPI data1 negative signal of MIPI Port B		/
13	GND	Ground		
14	DSI_B_D0P	MIPI data0 positive signal of MIPI Port B	I/O	
15	DSI_B_D0N	MIPI data0 negative signal of MIPI Port B	I/O	
16	GND	Ground	1/0	
17	VSP	Power supply for analog positive		
18	VSN	Power supply for analog positive		
19	GND	Ground	_	
20	LEDK1	LED cathode 1		
21	LEDK2	LED cathode 2		
22	LEDK3(NC)	Non connect		
23	LEDK4(NC)	Non connect		
24	LEDA	LED anode		
25	LEDA	LED anode		
26	GND	Ground	-	
27	MIP			
28	IOVCC	Power supply for I/O	<u>-</u>	<i>(1.11.</i> A. 1.1.
29	RESX	Reset enable pin	ı	"L" Active
30	IM LOD DV/M	De ablight LED drives DVAA	0	
31	LCD_PWM	Backlight LED driver PWM	0	
32	TE H-SYNC	Tearing signal output from driver IC Last data line STB of gate line period	0	
34	ID1	ID Pin		
35	GND	Ground	_	
36	DSI_B_D3N	MIPI Data3 negative of MIPI port B	1	
37	DSI_B_D3P	MIPI Data3 positive of MIPI port B	i	
38	GND	Ground	· .	
39	DSI_B_CLKN	MIPI clock negative signal of MIPI Port B		
	DSI_B_CLKP	MIPI clock positive signal of MIPI Port B	· ·	
40	GND	Ground	<u>'</u>	
41	DSI_B_D2N	MIPI data2 negative signal of MIPI Port B		
42		5 5	1	
43	DSI_B_D2P	MIPI data2 positive signal of MIPI Port B	ı	
44	GND DCL A D4D	Ground	- 1	
45	DSI_A_D1P	MIPI data1 positive signal of MIPI Port A	<u> </u>	
46	DSI_A_D1N	MIPI data1 negative signal of MIPI Port A	I	
47	GND	Ground	-	
48	DSI_A_D0P	MIPI data0 positive signal of MIPI Port A	I/O	
49	DSI_A_D0N	MIPI data0 negative signal of MIPI Port A	I/O	



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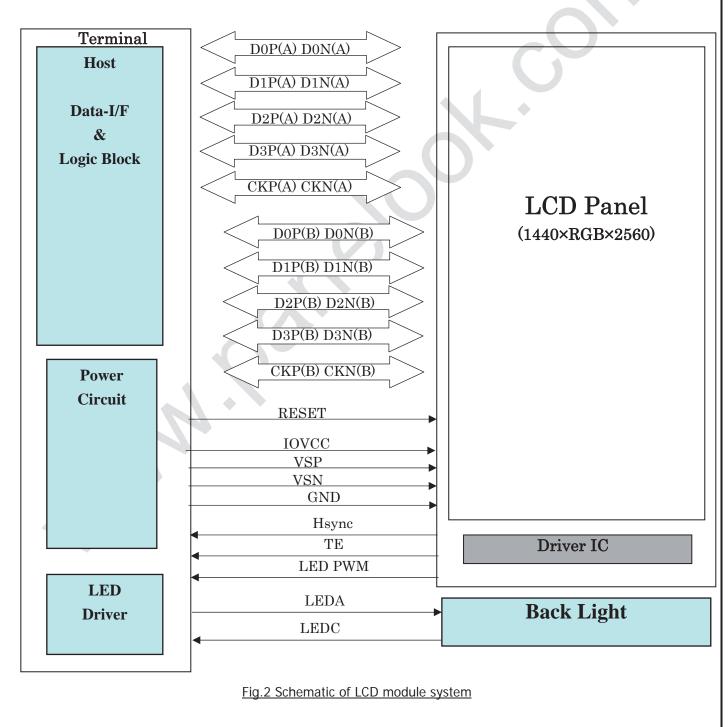
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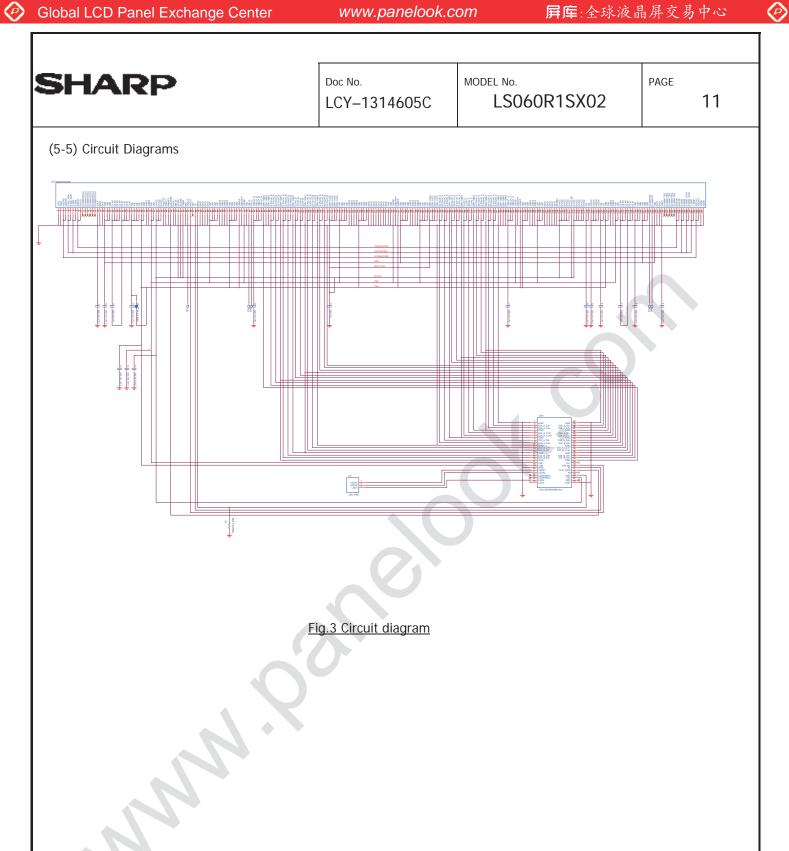
Mounted : 50pins; 0.4mm pitch; B to B connector. (JAE : WP7B-P050VA1) connector Corresponded connector : 50pins; 0.4mm pitch; B to B connector. (JAE : WP7B-S050VA1)

Signals connect to LCD module. Symbols correspond able to Circuit diagram in Page 11.

(5-4) Schematic of LCD module system







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②

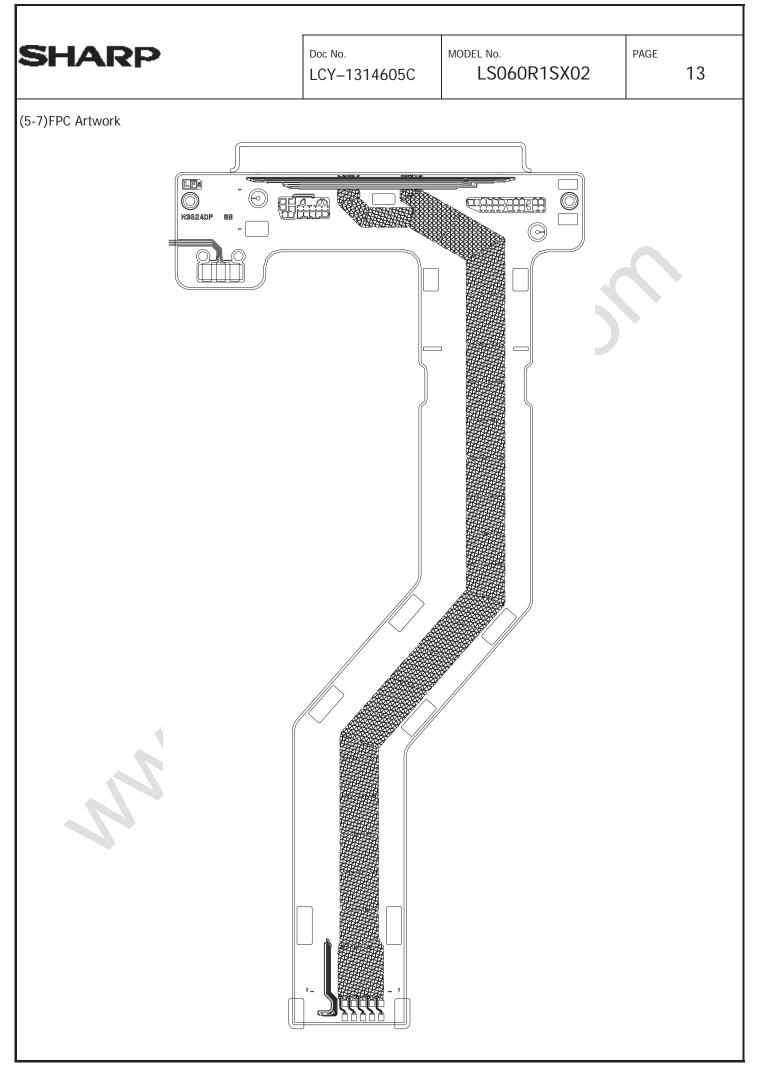


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(5-6) Parts List

Table 7

Category	Ref. No.		Spec		Vendor		
	C1	2.2uF	16V	1005	Multi Vendor		
	C2	2.2uF	6.3V	1005	Multi Vendor		
	C3	1.0uF	25V	1005	Multi Vendor		
	C4	2.2uF	16V	1005	Multi Vendor		
	C5	1.0uF	6.3V	1005	Multi Vendor		
	C7	1.0uF	6.3V	1005	Multi Vendor		
	C8	2.2uF	6.3V	1005	Multi Vendor		
Capacitor	C9	2.2uF	6.3V	1005	Multi Vendor		
	C10	1.0uF	6.3V	1005	Multi Vendor		
	C11	1.0uF	25V	1005	Multi Vendor		
	C12	2.2uF	16V	1005	Multi Vendor		
	C13	2.2uF	16V	1005	Multi Vendor		
	C14	2.2uF	10V	1005	Multi Vendor		
	C15	2.2uF	10V	1005	Multi Vendor		
	C16	2.2uF	6.3V	1005	Multi Vendor		
Diode	D1	VF<0.4V VR≧	max.25V		ROHM		
Connector	CN	0.4mm pitch /	0.4mm pitch / 50Pin				
Resister	R1	100kOhm/100	05/0.063W		Multi Vendor		





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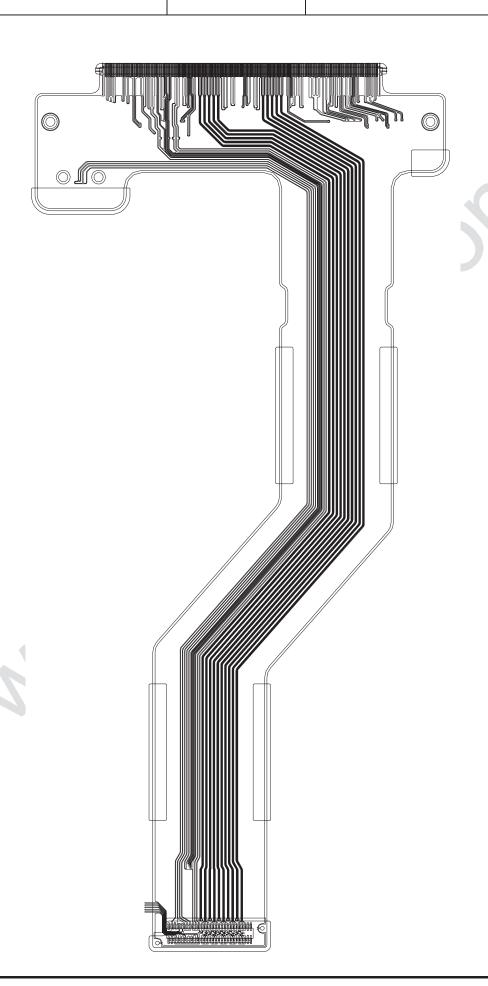
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6. Timing characteristics of input signals

(6-1)MIPI DC/AC Characteristics

<DC characteristics>

Table 8 Ta=+25°C, GND=0V

able 8									
	Item	Symbol	Unit	Test condition	Min.	Тур.	Max.	Note	
	Differential input high threshold	VIDTH	mV	IOVDD= 1.65V~3.30V	-	-	70	2	
	Differential input low threshold	VIDTL	mV	IOVDD= 1.65V~3.30V	-70	-	-	2	
	Single-ended input low voltage	VILHS	mV	IOVDD= 1.65V~3.30V	-40	-	-		
HS-RX	Single-ended input high voltage	VIHHS	mV	IOVDD= 1.65V~3.30V	-	-	460		
	Common-mode voltage HS receive mode	VCMRX(DC)	mV	IOVDD= 1.65V~3.30V	70	-	330	1	
	Differential input impedance	ZID	Ω	IOVDD= 1.65V~3.30V	-	100	-		
	Logic 0 input voltage not in ULP State	VIL	mV	IOVDD= 1.65V~3.30V	-50	-	550		
LP-RX	Logic 1 input voltage	VIH	mV	IOVDD= 1.65V~3.30V	880	-	1350		
	I/O leakage current	ILEAK	μA	Vin = -50mV - 1350mV	-10	-	10		
	Thevenin output low level	VOL	mV	IOVDD= 1.65V~3.30V	-50	-	50		
LP-TX	Thevenin output high level	VOH	V	IOVDD= 1.65V~3.30V	1.1	1.2	1.3		
	Output impedance of LP transmitter	ZOLP	Ω	IOVDD=1.80V	110	-	-		
	Logic 0 contention threshold	VILCD	mV	IOVDD= 1.65V~3.30V	-	-	200		
CD-RX	Logic 1 contention threshold	VIHCD	mV	IOVDD= 1.65V~3.30V	450	-	-		

Notes: 1. VCMRX (DC) = (VP+VDN)/2

2. Minimum 110mV/-110mV HS differential swing is required for display data transfer.

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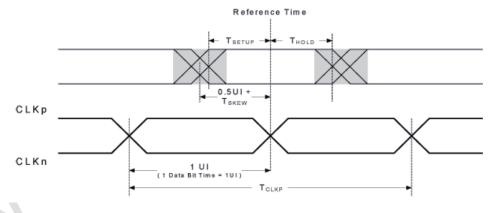
<AC Characteristics>

Table 9 Ta=+25°C, GND=0V

Item	Symbol	Unit	Test condition	Min.	Тур.	Max.	Note
DSICLK Frequency	fDSICLK	MHz	IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V	100	-	500	1
DSICLK Cycle time	tCLKP	ns	IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V	1	-	10	
DSI Data Transfer Rate	tDSIR	Mbps	IOVCC=1.65V~ 3.30V DPHYVCC=1.65V~ 3.30V DSI 2 lanes, 3 lanes,4lane	200	-	1000	1
Data to Clock Setup Time	tSETUP	UI	DPHYVCC=1.65V~ 3.30V	0.15	-	-	3
Data to Glock Cotup Time		ns	DPHYVCC=1.65V~ 3.30V	0.15	-	-	2 ,3
Clock to Data Hold Time	tHOLD	UI	DPHYVCC=1.65V~ 3.30V	0.15	-	-	3
		ns	IOVCC=1.85V~ 3.30V DPHYVCC=1.65V~ 3.30V	0.15	-	-	2,3

Notes: 1. When fDSICLK<125MHz, change auto load NV setting so that it is compliant with THS-PREPARE+THS-ZERO spec.

- 2. Minimum tSETUP/tHOLD Time is 0.15UI. This value may change according to DSI transfer rate.
- 3. tSETUP/tHOLD Time are measured without HS-TX Jitter.





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(6-2) Reset Timing Characteristics

Table 10 Ta=+25°C, GND=0V

Item	Symbol	Unit	Test condition	Min.	Max.
Reset low-level width1	tRW1	us	Power supply on	1000	_
Reset low-level width2	tRW2	us	Operation	1000	_
Reset time (Sleep IN)	tRT1	ms	-	1	3
Reset time (Sleep OUT)	tRT2	ms	-	_	3
Noise reject width	tRESNR	us	_	_	1

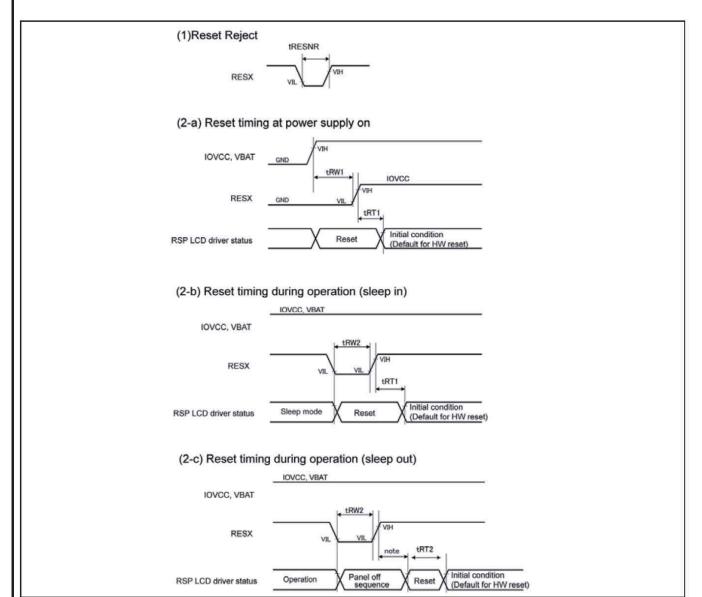


Fig .6 Reset timing characteristics



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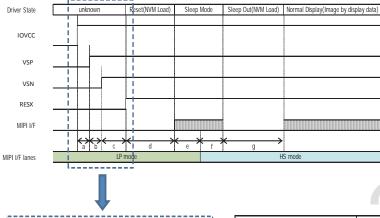
LS060R1SX02

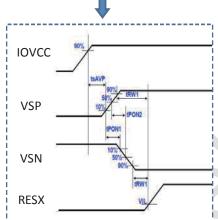
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7. Initial Sequence

(7-1) Power On Sequence (command mode)





Item	Symbol	min
VSP to VSN delay time (10% to 10%)	tPON1	0ms
VSP to VSN delay time (50% to 50%)	tPON2	0ms
System power on to VSP ON time	tsAVP	ims
Reset low-level width	tRW1	1ms



<Command mode>

<u> </u>	mmanu r	Houe>						
				Recomi	mended Po	wer On Sequenc	ce	term
Step	Address	Parameter	Data	DSI dat	a type	Delay	Command	
1	Initial condition	ı					RESX = L	
2	Power Supply	IOVCC (Typ1.8)	V)				IOVCC ON	
3	Wait					tsAVP	Wait until power stable	a.
4	Power Supply	VSP (Typ5.75V))				VSP ON	
5	Wait					tPON1/tPON2		b.
6	Power Supply	VSN (Typ-5.75)	V)				VSN ON	
7	Wait					tRW1		C.
8	RESET High						RESX = H	
9	Wait					Min.10 ms	[Automatic] NVM Auto load	d.
10							[Automatic] Sleep Mode On	
	0xB0	P1	00h	Generic	29h		The command to unlock manufacturing command write (CABC, CE etc.)	
	0xD6	P1	01h	Generic	29h		The command to remove NVM reload after sleep out.	
	0xB3	P1	08h	Generic	29h		MIPI Command mode=08h	
	0x51	P1	FFh	DCS	39h		Display Brightness = 100%	
	0x53	P1	0Ch	DCS	39h		LED PWM output enable / Dimming function ON	
11	0x35	P1	00h	DCS	39h		TE enable	e.
	0x2A	P1	00h	DCS	39h		start Column address : 000h	
		P2	00h					
		P3	05h				end Column address : 59Fh (1439)	
		P4	9Fh					
		ed, please add	initial comma	nd in here.				
	0xB0	P1	03h	Generic	29h		The command to lock manufacturing command write	
12	Display data tr	ansfer					Image Write	
13	0x29	-	-	DCS	39h		Display On	f.
14	0x11	-	-	DCS	39h		Sleep Out	
15	Wait					Min.6 frame		g.
16							[Automatic] Sleep Mode Off/Display On	9.

Table 11-1





Doc No.

MODEL No.

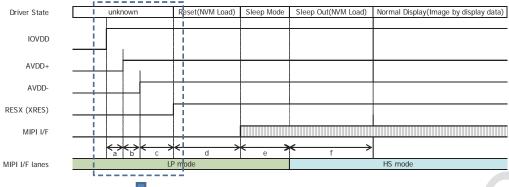
LCY-1314605C

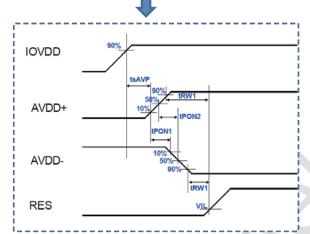
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(7-2) Power On Sequence (Video mode)





Item	Symbol	min
AVDD+ to AVDD- delay time (10% to 10%)	tPON1	0ms
AVDD+ to AVDD- delay time (50% to 50%)	tPON2	0ms
System power on to AVDD+ ON time	tsAVP	-1ms
Reset low-level width	tRW1	1ms

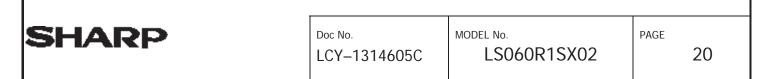


<Video mode>

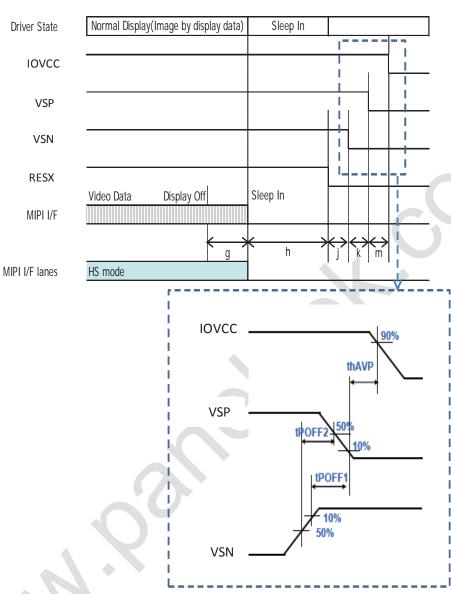
				Docomo	nended Power	On Seguence		
								term
Step		Parameter	Data	DSI da	ta type	Delay	Command	
1	Initial condition						XRES = L	
2	Power Supply IO	VDD (Typ1.8V)					IOVDD ON	
3	Wait					tsAVP	Wait until power stable	a.
4	Power Supply AV	'DD+ (Typ5.75V)					AVDD+ ON	
5	Wait					tPON1/tPON2		b.
6	Power Supply AV	DD- (Typ-5.75V)		A 3			AVDD- ON	
7	Wait					tRW1		C.
8	RESX High						XRES = H	
9	Wait					Min.10 ms	[Automatic] NVM Auto load	d.
10							[Automatic] Sleep Mode On	
	0xB0	P1	00h	Generic	29h		The command to unlock manufacturing command write	
	UXBU	PI	oon	Generic	29h		(CABC, CE etc.)	
	0xD6	P1	01h	Generic	29h		The command to remove NVM reload after sleep out.	
	0xB3	P1	18h	Generic	29h		MIPI Video through mode=18h	
	0x51	P1	FFh	DCS	39h		Display Brightness = 100%	
	0x53	P1	0Ch	DCS	39h		LED PWM output enable / Dimming function ON	e.
11	0x35	P1	00h	DCS	39h		TE enable	
	If customer need	, please add initial	command in her	e.				
	0xB0	P1	03h	Generic	29h		The command to lock manufacturing command write	
12	0x29	-	-	DCS	39h		Display On	
13	0x11	-	-	DCS	39h		Sleep Out	
14	Host Display Data	transfer					Image Write(Send Video Stream Packet)	
15	Wait					Min.6 frame	,	f.
16							[Automatic] Sleep Mode Off/Display On	

Table 11-2





(7-3) Power Off Sequence(Command mode)



Item	Symbol	Min
VSN to VSP delay time (10% to 10%)	tPOFF1	0ms
VSN to VSP delay time (50% to 50%)	tPOFF2	0ms
VSP off to system power off time	thAVP	100ms

<Command mode>

				Reco	mmended Po	wer Off Sequence		
Step	Address	Parameter	Data	DSI da	ita type	Delay	Command	term
1	28h	-	-	DCS	39h		Display Off	0
2	Wait					Min.1 frame		g
3	10h	-	-	DCS	39h		Sleep In	h
4	Wait					Min. 4frame		h
5	RESET Low						RESX = L	
6	Wait					Min.0ms		,
7	VSN(Typ-5.75V)	OFF						k
8						tPOFF1/tPOFF2	Wait	Λ.
9	VSP(Typ+5.75V)	OFF						
10						thAVP	Wait	m
11	IOVCC OFF(Typ1	.8V) OFF						

Table 12-1



Doc No.

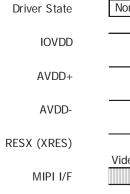
MODEL No.

LCY-1314605C

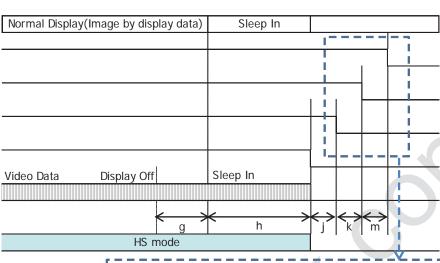
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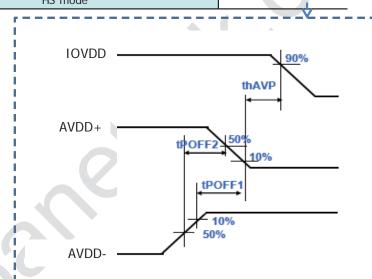
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(7-4) Power Off Sequence(Video mode)



MIPI I/F lanes





Symbol	Min
tPOFF1	0ms
tPOFF2	0ms
thAVP	100ms
	tPOFF1

<Video mode>

Recommended Power Off Sequence								
Step	Address	Parameter	Data	DSI da	ita type	Delay	Command	term
1	28h	-	-	DCS	39h		Display Off	α
2	Wait					Min.1 frame		g
3	10h	-	-	DCS	39h		Sleep In	h
4	Wait					Min. 4frame	Hsync/Vsync signals should be send after Sleep In command	"
5							Mipi data transfer Stop	
6	RESX Low						XRES = L	
7	Wait					Min.0ms		J
8	AVDD-(Typ-5.75	V) OFF						le .
9						tPOFF1/tPOFF2	Wait	K
10	AVDD+(Typ+5.7	5V) OFF						
11						thAVP	Wait	m
12	IOVDD OFF(Typ1	1.8V) OFF						

Table 12-2



②

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8. Mipi Video Setting

Condition

- ·DSI 4Lane, 2port
- -850Mbps/Lane

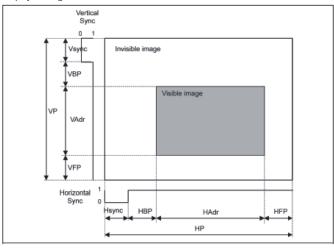
Vertical Display Timing

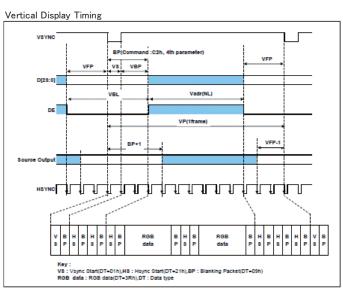
Item	Symbol	Condition	Unit	Value
Vertical cycle	VP		Line	2568
Vertical low pulse width	VS		Line	1
Vertical front porch	VFP		Line	4
Vertical back porch	VBP		Line	3
Vertical data start point	-	BP	Line	4
vertical blanking period	VBL	VFP+BP	Line	8
Vertical active area	Vadr		Line	2560

Horizontal Display Timing Item Symbol Condition Unit Value Horizontal front porch HFP 100 ByteClock Horizontal data start point HS+HBP ByteClock Horizontal active area Hadr Pixel 1440

Frame Frequency:60.3Hz

Display Timing





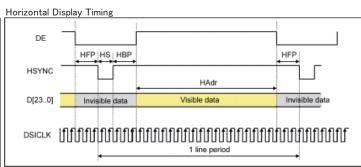


Table 13



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9. Optical Characteristics

Table 14

Parameter	symbol	condition	MIN	TYP	MAX	unit	Remark
Brightness	Br	θ=0°	315	450	-	cd/m [*]	Note1,2
Response Time	тr +тd	θ=0°			35	ms	Note5
Contrast	Со	θ=0°	900	1300	-		Note1,3
Viewing Angle	θ11	Co > 10	70	80	-	deg	Note1
	θ12		70	80	-		
	θ21	_	70	80	. •		
	θ22		70	80	-		
White chromaticity	Х	θ=0°	0.27	0.30	0.33		Note.1,3
	у		0.29	0.32	0.35		
Red chromaticity	х	θ=0°	0.62	0.65	0.68		
	у		0.31	0.34	0.37		
Green chromaticity	х	θ=0°	0.28	0.31	0.34		
	у		0.58	0.61	0.64		
Blue chromaticity	х	θ=0°	0.13	0.16	0.19		
	у		0.04	0.07	0.10		
Uniformity	-	θ=0°	70	-	-	%	Note.4
NTSC ratio	I.P.	θ=0°		70	-	%	Note.1,3



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Note 1) Definition of range of visual angle

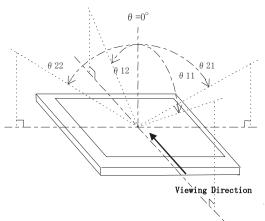


Fig .7 Definition of viewing angle

Note 2) Brightness is measured as shown in Fig.5, and is defined as the brightness of all pixels "White" at the center of display area on optimum contrast.

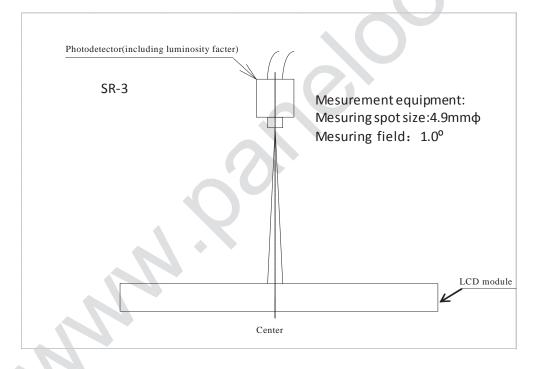


Fig. 8 Optical characteristics Test Method (Brightness)

Note 3) Contrast ratio is defined as follows:

Luminance(brightness) all pixcels "White" Luminance(brightness) all pixcels "Black"



Note 4) Uniformity is defined as follows:

Uniformity = Minimum Luminance(brightness) in 9 points

Maximum Luminance(brightness) in 9 points

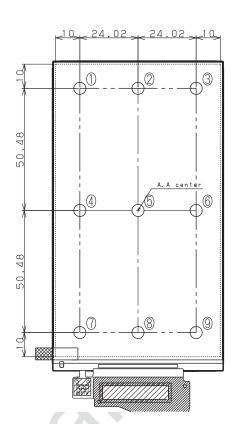
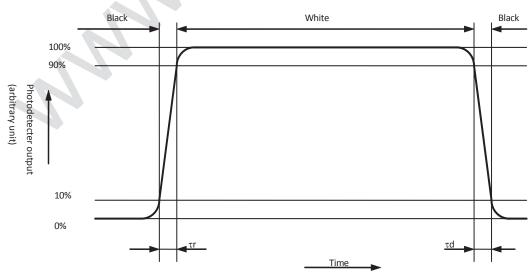


Fig. 9 Measuring Point

Note 5) Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white"



 $\underline{\text{Fig. 10 Definition of response time}}$

\(\phi\)

_			
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10. Reliability

Table.15

	<u>1dble:15</u>				
No.	Test	Condition			
1	High temperature storage test	Ta=70°C, 240h			
2	Low temperature storage test	Ta=-30°C, 240h			
3	High temperature Operation test	Ta=60°C, 240h			
4	Low temperature Operation test Ta=-20°C, 240h				
5	Humidity Operation	Ta=40°C 95%RH, 240h			
6	Heat shock test	Ta = -30°C(30min) to 70°C(30min), 20cycle			
7	Electro static discharge test	$\pm 200V$, $200pF(0\Omega)$ to Terminals(Contact)			
		(1 time for each terminals)			

^{*} Ta=Ambient temperature

In the standard condition, there shall be no practical problems that may affect the display function.

^{*}Check items for other test



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11. Packaging specifications

(11-1) Details of packaging

1) Packaging materials: Table.17 2) Packaging style : Fig. 11, 12

(11-2) Reliability

1) Vibration test

Table.16

Item	Test					
Frequency	5 Hz to 50 Hz (3 minutes cycle)					
Direction	Up-Down, Left-Right, Front-Back (3 directions)					
Period	Up-Down Left-Right Front-Back Total					
	60min	15min	15min	90min		

The frequency should start at 5 Hz and vary continuously.

Total amplitude 20mm 20mm 0.2mm 0.2mm

5 Hz $(For 9.8 \text{m/s}^2)$ Frequency 5 Hz 50 Hz 50 Hz

> 0 - 3 minutes -

2) Drop test

Drop height: 900mm

Number of drop: 10 times (Drop sequence: 1 corner, 3 edges, 6 faces)

(11-3) Packaging quantities

160 modules per master carton

(11-4) Packaging weight

About 9.1 kg

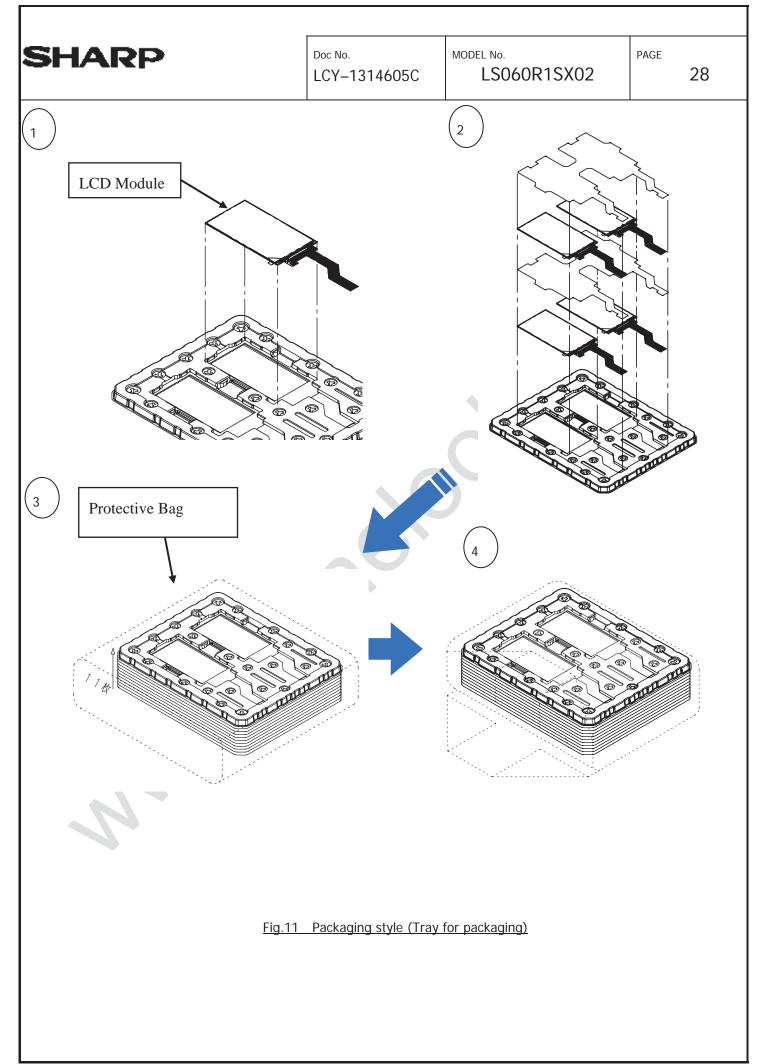
(11-5) Packaging outline dimensions

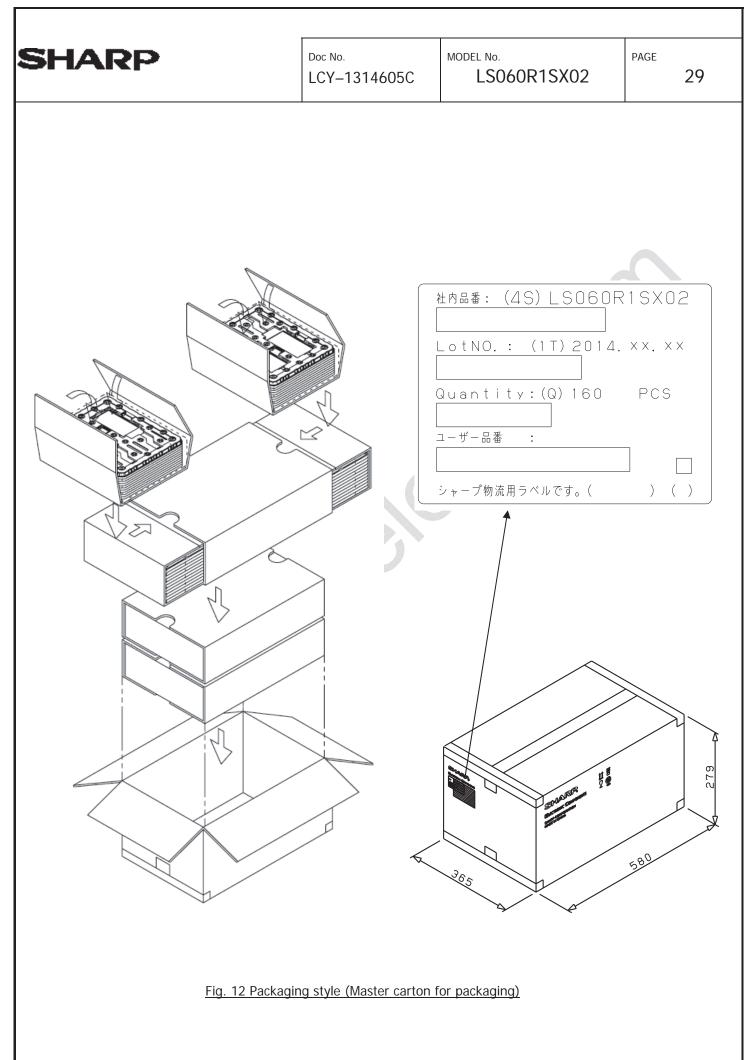
 $365 \text{ mm} \times 580 \text{ mm} \times 279 \text{ mm}$ (H)

(Packaging materials)

Table 17

	Parts name	Materials
1	Master carton	Corrugate card board
2	Inside sleeve	Corrugate card board
3	Outside sleeve	Corrugate card board
4	Tray for packaging	Polystyrene with anti-static treatment + anti-static polystyrene
5	Protective bag	Polyethylene with anti-static treatment
6	OPP tape	Polypropylene
7	Bar code label	Anti-static polyethylene





Global LCD Panel Exchange Center

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12. Serial Number Label identification

Numbering is specified as follows.

4 6 000001 L

- 1 2 3
- **(4**)
- ① product year (lower 1 digits)

4: 2014

5: 2015

2 product month

(1,2,3, 4, 5, 6, 7, 8, 9 X,Y,Z)

X: October

Y: November

Z: December

3 serial number

000001 ~ 999999

4 factory code

13. LCD Module Code Rule

<u>LS 060 R 1 S X 02</u>

- 1
- 2

- 3 4 5 6 7

①Parts type

CGS LCD

2 Active area size

5.98 inch

3Dot format

WQHD format

4 LCD type

Transmissive

5 Interface type

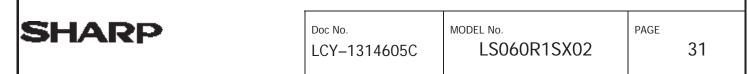
MIPI DSI 4 Lane, 2ports

6 Polarizer / LCD viewing type

Clear type / Wide viewing angle

7)Serial Code





14. Outline dimensions

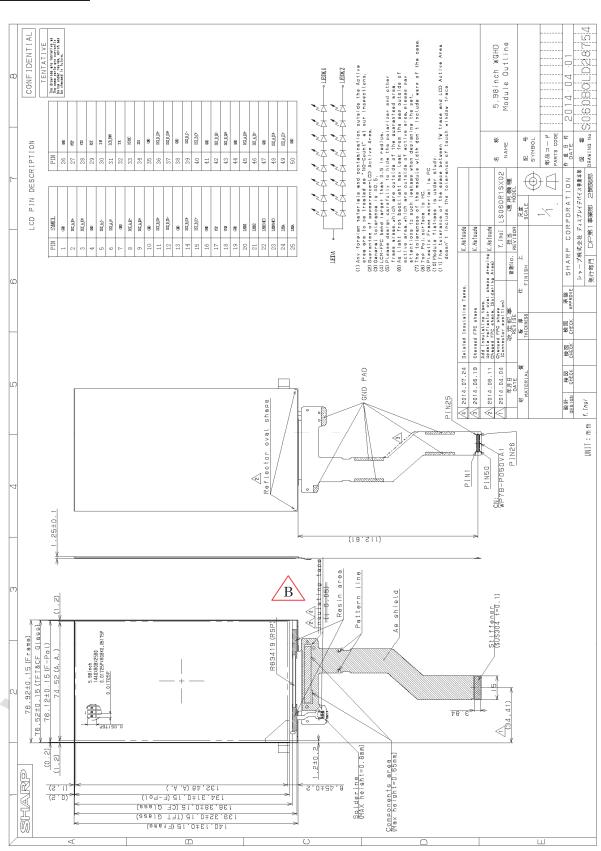


Fig. 13 Outline dimensions